

12500 TI Boulevard, MS 8640, Dallas, Texas 75243

Notification# 20180118003 Datasheet for TPA3221 Information Only

Date: February 05, 2018 **To:** PREMIER FARNELL PCN

Dear Customer:

This is an information-only announcement of a change to the datasheet for a device that is currently offered by Texas Instruments.

The changes discussed within this notification are for your information only.

Any negotiated alternative change requirements will be provided via the customer's defined process. Customers with previously negotiated, special requirements will be handled separately. Any inquiries should be directed to your local Field Sales Representative.

For questions regarding this notice, contact your local Field Sales Representative or the PCN Manager (PCN www admin team@list.ti.com).

Sincerely,

PCN Team SC Business Services

Information Only Attachments

Products Affected:

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

DEVICE TPA3221DDV

CUSTOMER PART NUMBER

null

Technical details of this Product Change follow on the next page(s).

PCN Number:		20180118003		PCN Date:	February 5,		2018	
Title:	Datasheet for					Tebruary 3, 2010		
Customer Contact: PCN Manager					ept:	Quality Services		
Change Type:								
			Design	Design			Wafer Bump Site	
		Data Sheet				Vafer Bump Material		
		Part number change			Wafe	r Bump Process		
			Test Site				r Fab Site	
Packing/Shipping/Labeling		Test Proce	Test Process			r Fab Materials		
	Notification Details Wafer Fab Process							
Description of Change:								
Texas Instruments Incorporated is announcing an information only notification. The product datasheet(s) is being updated as summarized below. The following change history provides further details. TEXAS INSTRUMENTS TPA3221 SLASEE9B—SEPTEMBER 2017—REVISED DECEMBER 2017 Changes from Revision A (November 2017) to Revision B Changed OUT_P To: OUT1_P for 1 x BTL in Table 1 Added pins OSCM, OSCP to the Interface pins in the Absolute Maximun Ratings table								
 Changed the T_J MIN value From: 0°C To –40°C in the Absolute Maximun Ratings table								
	The datasheet number will be changing Device Family			Change From:			je To:	
	, TPA3221					SLASE		
TPA3221 SLASEE9A SLASEE9B These changes may be reviewed at the datasheet links provided. http://www.ti.com/product/TPA3221 Reason for Change:								
To accurately reflect device characteristics.								
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):								
No anticipated impact. This is a specification change announcement only. There are no changes to the actual device. Changes to product identification resulting from this PCN:								
None.								
_	ct Affected:					-		
TPA3	221DDV	TPA3221DD\	/R					

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com